Renesas Electronics America Inc - UPD78F0484GK-GAK-AX Datasheet

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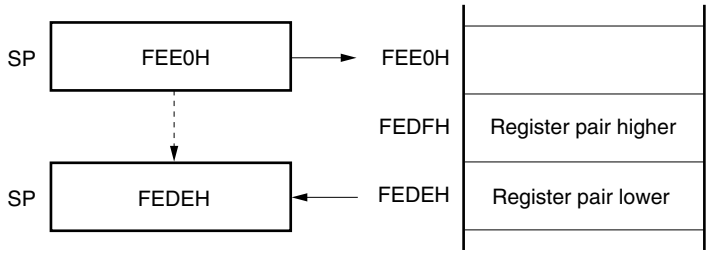
Applications of "Embedded - Microcontrollers"

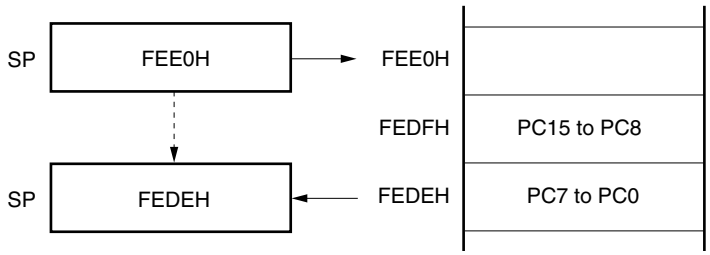
Details	
Product Status	Active
Core Processor	78K/0
Core Size	8-Bit
Speed	10MHz
Connectivity	3-Wire SIO, LINbus, UART/USART
Peripherals	LCD, LVD, POR, PWM, WDT
Number of I/O	62
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/upd78f0484gk-gak-ax

Figure 3-24. Data to Be Saved to Stack Memory

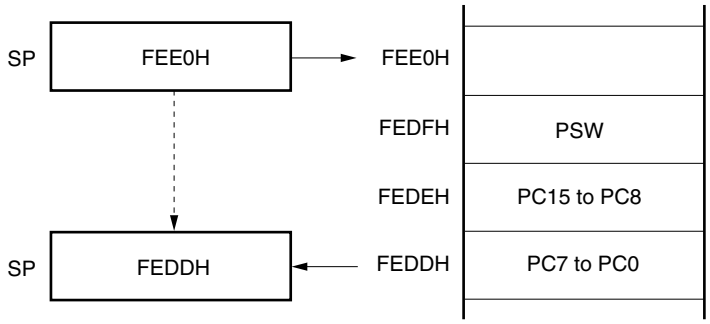
(a) PUSH rp instruction (when SP = FEE0H)



(b) CALL, CALLF, CALLT instructions (when SP = FEE0H)



(c) Interrupt, BRK instructions (when SP = FEE0H)



3.4.6 Register indirect addressing

[Function]

Register pair contents specified by a register pair specify code in an instruction word and by a register bank select flag (RBS0 and RBS1) serve as an operand address for addressing the memory. This addressing can be carried out for all of the memory spaces.

[Operand format]

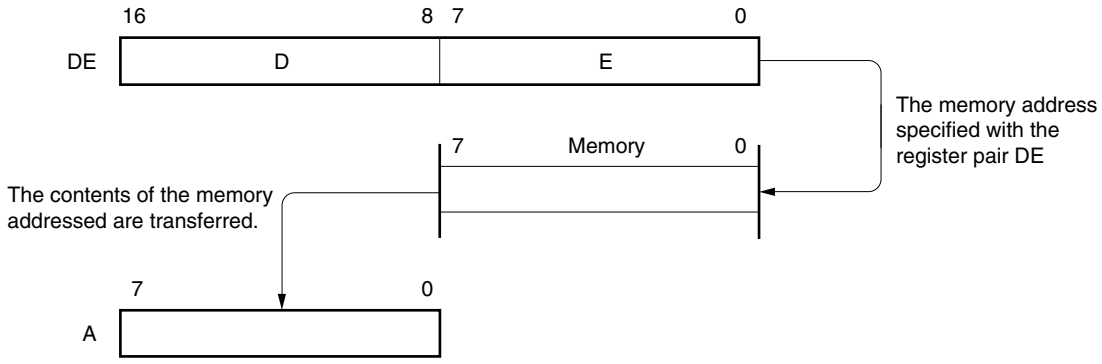
Identifier	Description
–	[DE], [HL]

[Description example]

MOV A, [DE]; when selecting [DE] as register pair

Operation code	1	0	0	0	0	1	0	1

[Illustration]



4.2 Port Configuration

Ports include the following hardware.

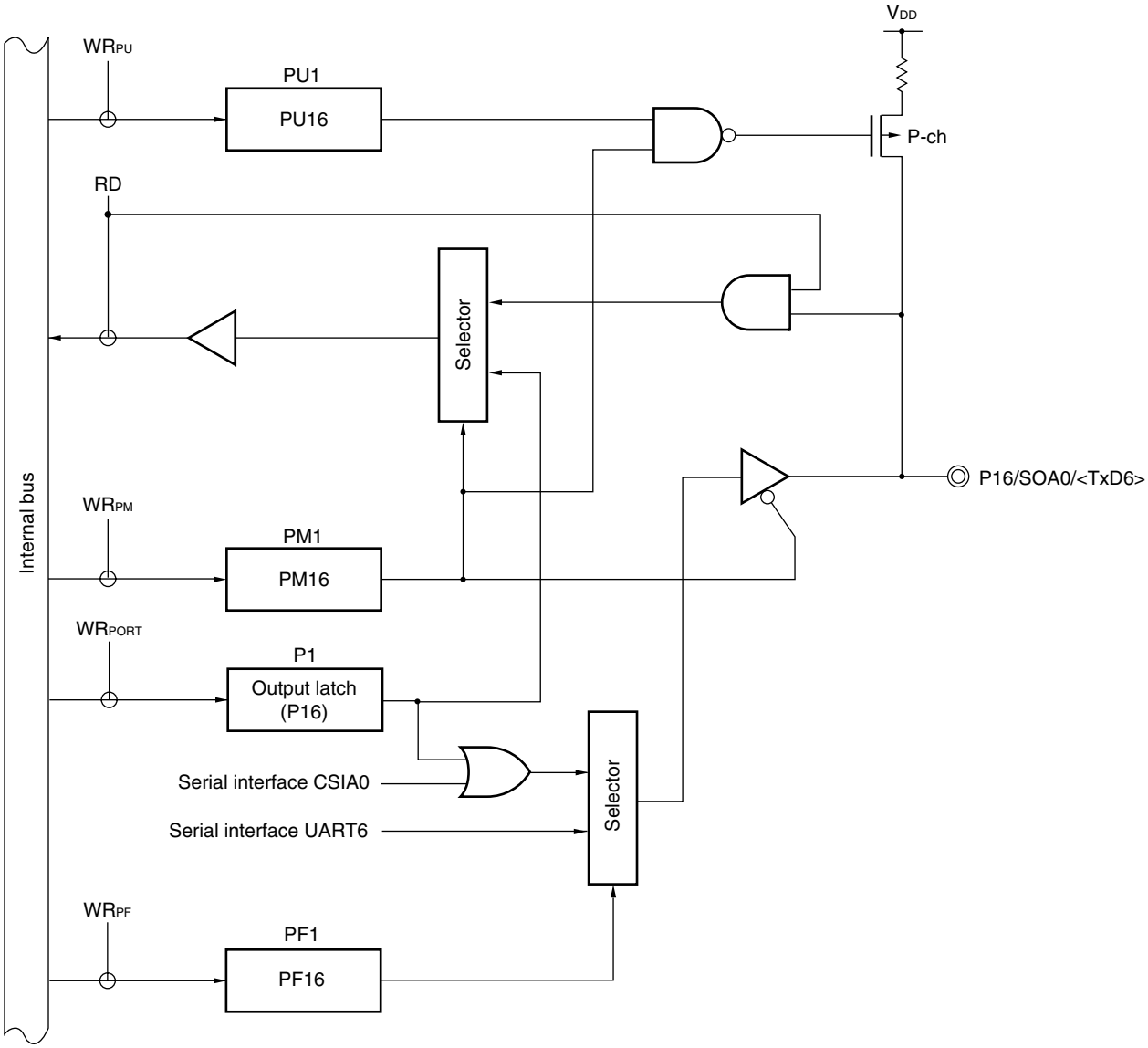
Table 4-3. Port Configuration

Item	Configuration
Control registers	Port mode register (PM1 to PM4, PM8 to PM15) Port register (P1 to P4, P8 to P15) Pull-up resistor option register (PU1, PU3, PU4, PU8 to PU15) Port function register 1 (PF1) Port function register 2 (PF2)[Note 1] Port function register ALL (PFALL) A/D port configuration register 0 (ADPC0)[Note 2]
Port	Total: 62
Pull-up resistor	Total: 50

Notes 1. μPD78F047x and 78F048x only

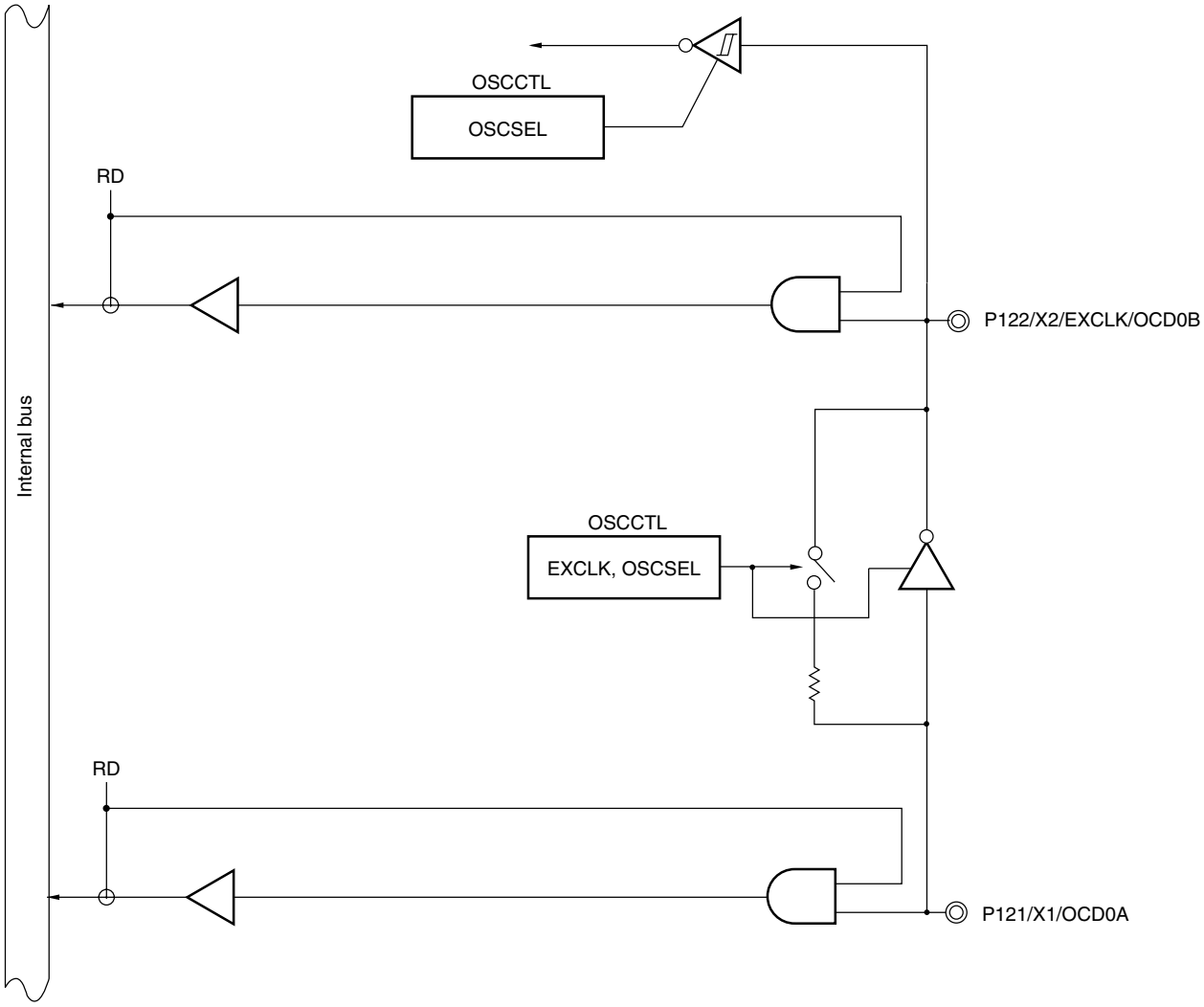
2. μPD78F048x and 78F049x only

Figure 4-6. Block Diagram of P16



P1: Port register 1
PU1: Pull-up resistor option register 1
PM1: Port mode register 1
PF1: Port function register 1
RD: Read signal
WR××: Write signal

Figure 4-22. Block Diagram of P121 and P122



OSCCTL: Clock operation mode select register
RD: Read signal

6.4.4 Operation in clear & start mode entered by TI000 pin valid edge input

When bits 3 and 2 (TMC003 and TMC002) of 16-bit timer mode control register 00 (TMC00) are set to 10 (clear & start mode entered by the TI000 pin valid edge input) and the count clock (set by PRM00) is supplied to the timer/event counter, TM00 starts counting up. When the valid edge of the TI000 pin is detected during the counting operation, TM00 is cleared to 0000H and starts counting up again. If the valid edge of the TI000 pin is not detected, TM00 overflows and continues counting.

The valid edge of the TI000 pin is a cause to clear TM00. Starting the counter is not controlled immediately after the start of the operation.

CR000 and CR010 are used as compare registers and capture registers.

(a) When CR000 and CR010 are used as compare registers

Signals INTTM000 and INTTM010 are generated when the value of TM00 matches the value of CR000 and CR010.

(b) When CR000 and CR010 are used as capture registers

The count value of TM00 is captured to CR000 and the INTTM000 signal is generated when the valid edge is input to the TI010 pin (or when the phase reverse to that of the valid edge is input to the TI000 pin).

When the valid edge is input to the TI000 pin, the count value of TM00 is captured to CR010 and the INTTM010 signal is generated. As soon as the count value has been captured, the counter is cleared to 0000H.

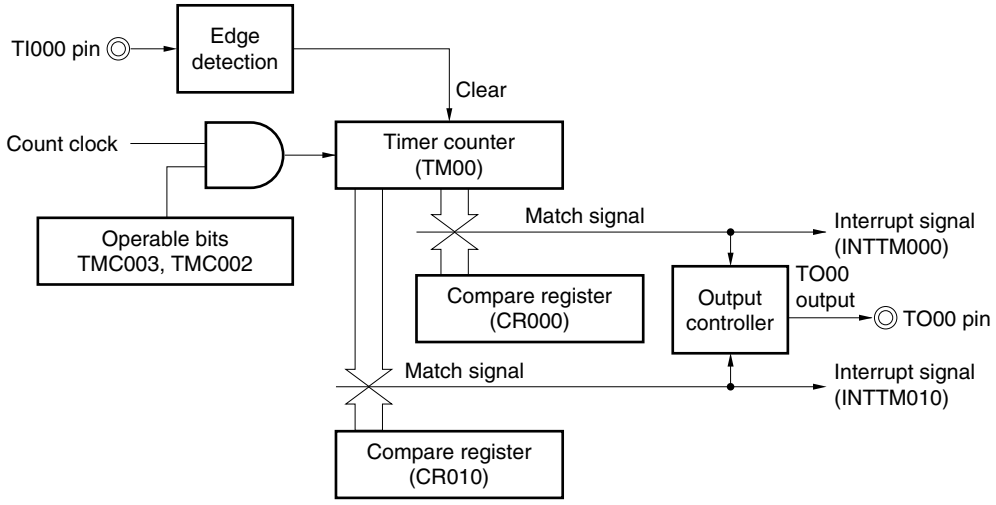
Caution Do not set the count clock as the valid edge of the TI000 pin (PRM002, PRM001, and PRM000 = 110). When PRM002, PRM001, and PRM000 = 110, TM00 is cleared.

Remarks 1. For the setting of the I/O pins, see **6.3 (6) Port mode register 3 (PM3)**.

2. For how to enable the INTTM000 signal interrupt, see **CHAPTER 21 INTERRUPT FUNCTIONS**.

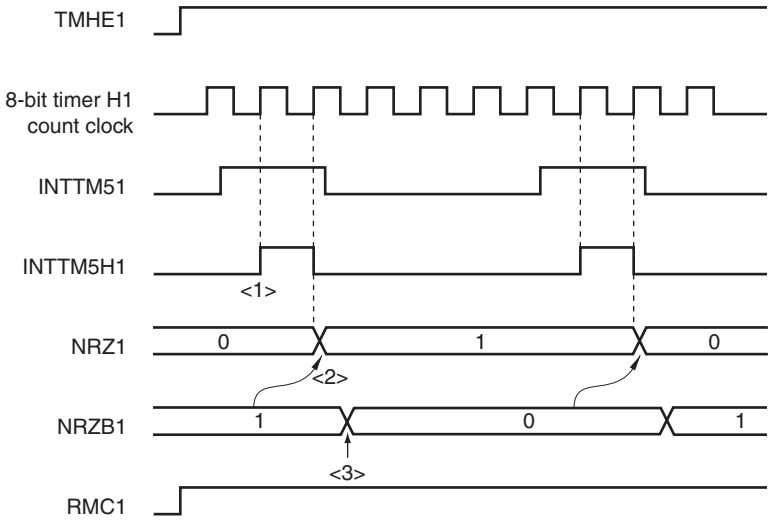
(1) Operation in clear & start mode entered by TI000 pin valid edge input (CR000: compare register, CR010: compare register)

Figure 6-23. Block Diagram of Clear & Start Mode Entered by TI000 Pin Valid Edge Input (CR000: Compare Register, CR010: Compare Register)



To control the carrier pulse output during a count operation, the NRZ1 and NRZB1 bits of the TMCYC1 register have a master and slave bit configuration. The NRZ1 bit is read-only but the NRZB1 bit can be read and written. The INTTM51 signal is synchronized with the 8-bit timer H1 count clock and is output as the INTTM5H1 signal. The INTTM5H1 signal becomes the data transfer signal of the NRZ1 bit, and the NRZB1 bit value is transferred to the NRZ1 bit. The timing for transfer from the NRZB1 bit to the NRZ1 bit is as shown below.

Figure 8-15. Transfer Timing



<1> The INTTM51 signal is synchronized with the count clock of the 8-bit timer H1 and is output as the INTTM5H1 signal.

<2> The value of the NRZB1 bit is transferred to the NRZ1 bit at the second clock from the rising edge of the INTTM5H1 signal.

<3> Write the next value to the NRZB1 bit in the interrupt servicing program that has been started by the INTTM5H1 interrupt or after timing has been checked by polling the interrupt request flag. Write data to count the next time to the CR51 register.

Cautions 1. Do not rewrite the NRZB1 bit again until at least the second clock after it has been rewritten, or else the transfer from the NRZB1 bit to the NRZ1 bit is not guaranteed.

2. When the 8-bit timer/event counter 51 is used in the carrier generator mode, an interrupt is generated at the timing of <1>. When the 8-bit timer/event counter 51 is used in a mode other than the carrier generator mode, the timing of the interrupt generation differs.

Remark INTTM5H1 is an internal signal and not an interrupt source.

(2) Asynchronous serial interface reception error status register 0 (ASIS0)

This register indicates an error status on completion of reception by serial interface UART0. It includes three error flag bits (PE0, FE0, OVE0).

This register is read-only by an 8-bit memory manipulation instruction.

Reset signal generation, or clearing bit 7 (POWER0) or bit 5 (RXE0) of ASIM0 to 0 clears this register to 00H. 00H is read when this register is read. If a reception error occurs, read ASIS0 and then read receive buffer register 0 (RXB0) to clear the error flag.

Figure 14-3. Format of Asynchronous Serial Interface Reception Error Status Register 0 (ASIS0)

Address: FF73H After reset: 00H R

Symbol	7	6	5	4	3	2	1	0
ASIS0	0	0	0	0	0	PE0	FE0	OVE0

PE0	Status flag indicating parity error
0	If POWER0 = 0 or RXE0 = 0, or if ASIS0 register is read.
1	If the parity of transmit data does not match the parity bit on completion of reception.

FE0	Status flag indicating framing error
0	If POWER0 = 0 or RXE0 = 0, or if ASIS0 register is read.
1	If the stop bit is not detected on completion of reception.

OVE0	Status flag indicating overrun error
0	If POWER0 = 0 and RXE0 = 0, or if ASIS0 register is read.
1	If receive data is set to the RXB0 register and the next reception operation is completed before the data is read.

Cautions 1. The operation of the PE0 bit differs depending on the set values of the PS01 and PS00 bits of asynchronous serial interface operation mode register 0 (ASIM0).

2. Only the first bit of the receive data is checked as the stop bit, regardless of the number of stop bits.

3. If an overrun error occurs, the next receive data is not written to receive buffer register 0 (RXB0) but discarded.

4. If data is read from ASIS0, a wait cycle is generated. Do not read data from ASIS0 when the CPU is operating on the subsystem clock and the peripheral hardware clock is stopped. For details, see CHAPTER 34 CAUTIONS FOR WAIT.

(2) Error of baud rate

The baud rate error can be calculated by the following expression.

- $\text{Error (\%)} = \left(\frac{\text{Actual baud rate (baud rate with error)}}{\text{Desired baud rate (correct baud rate)}} - 1 \right) \times 100 \text{ [\%]}$

Cautions 1. Keep the baud rate error during transmission to within the permissible error range at the reception destination.

2. Make sure that the baud rate error during reception satisfies the range shown in (4) Permissible baud rate range during reception.

Example: Frequency of base clock = 10 MHz = 10,000,000 Hz
Set value of MDL67 to MDL60 bits of BRGC6 register = 00100001B (k = 33)
Target baud rate = 153600 bps

Baud rate = 10 M / (2 × 33)
= 10000000 / (2 × 33) = 151,515 [bps]

Error = (151515/153600 − 1) × 100
= −1.357 [%]

16.3 Registers Controlling Serial Interface CSI10

Serial interface CSI10 is controlled by the following five registers.

- Serial operation mode register 10 (CSIM10)
- Serial clock selection register 10 (CSIC10)
- Port function register 1 (PF1)
- Port mode register 1 (PM1)
- Port register 1 (P1)

(1) Serial operation mode register 10 (CSIM10)

CSIM10 is used to select the operation mode and enable or disable operation.

CSIM10 can be set by a 1-bit or 8-bit memory manipulation instruction.

Reset signal generation sets this register to 00H.

Figure 16-2. Format of Serial Operation Mode Register 10 (CSIM10)

Address: FF80H After reset: 00H R/W[Note 1]

Symbol	<7>	6	5	4	3	2	1	0
CSIM10	CSIE10	TRMD10	0	DIR10	0	0	0	CSOT10

CSIE10[Note 2]	Operation control in 3-wire serial I/O mode
0	Disables operation and asynchronously resets the internal circuit[Note 3].
1	Enables operation

TRMD10[Note 4]	Transmit/receive mode control
0[Note 5]	Receive mode (transmission disabled).
1	Transmit/receive mode

DIR10[Note 6]	First bit specification
0	MSB
1	LSB

CSOT10	Communication status flag
0	Communication is stopped.
1	Communication is in progress.

Notes 1. Bit 0 is a read-only bit.

2. To use P11/$\overline{\text{SCK10}}$, P12/SI10/RxD0, and P13/SO10/TxD0 as general-purpose port, clear CSIE10 to 0.

3. Bit 0 (CSOT10) of CSIM10 and serial I/O shift register 10 (SIO10) are reset.

4. Do not rewrite TRMD10 when CSOT10 = 1 (during serial communication).

5. The SO10 output (see **Figure 16-1**) is fixed to the low level when TRMD10 is 0. Reception is started when data is read from SIO10.

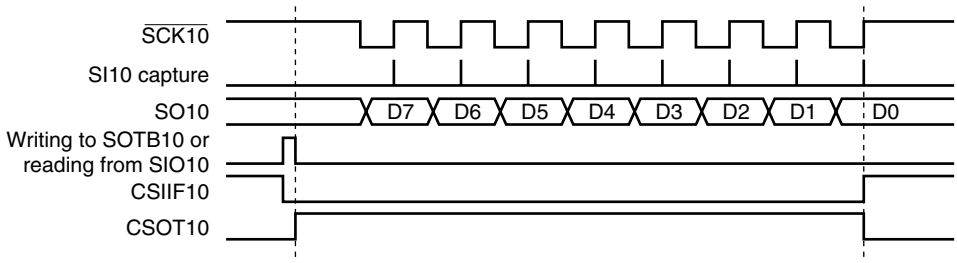
6. Do not rewrite DIR10 when CSOT10 = 1 (during serial communication).

Cautions 1. When resuming operation from standby status, do so after having cleared (0) bit 2 (CSIIF10) of interrupt request flag register 0H (IF0H).

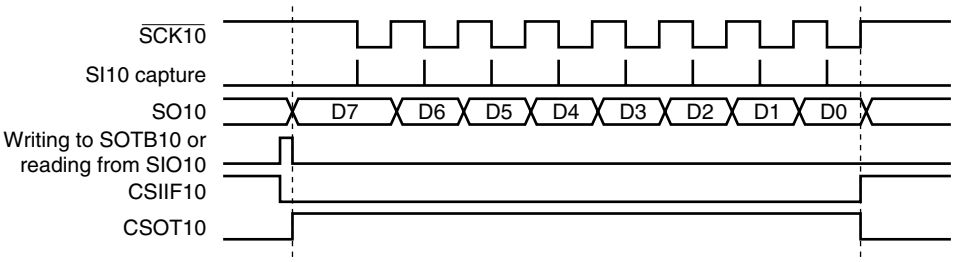
2. Be sure to clear bit 5 to 0.

Figure 16-7. Timing of Clock/Data Phase

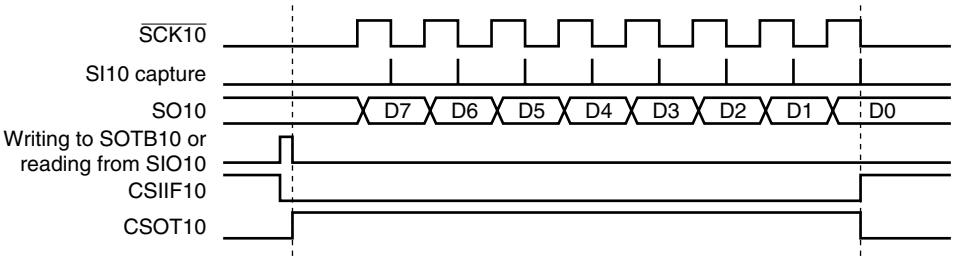
(a) Type 1: CKP10 = 0, DAP10 = 0, DIR10 = 0



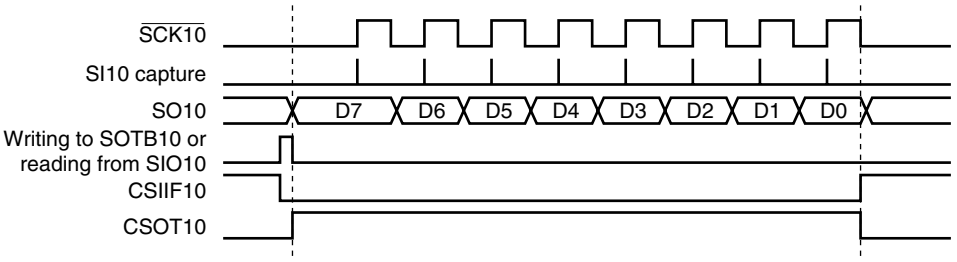
(b) Type 2: CKP10 = 0, DAP10 = 1, DIR10 = 0



(c) Type 3: CKP10 = 1, DAP10 = 0, DIR10 = 0



(d) Type 4: CKP10 = 1, DAP10 = 1, DIR10 = 0



Remark The above figure illustrates a communication operation where data is transmitted with the MSB first.

18.7.5 Eight-time-slice display example

Figure 18-31 shows how the 15×8 dots LCD panel having the display pattern shown in Figure 18-30 is connected to the segment signals (SEG4 to SEG18) and the common signals (COM0 to COM7) of the 78K0/LF3 chip. This example displays data "123" in the LCD panel. The contents of the display data memory (addresses FA44H to FA52H) correspond to this display.

The following description focuses on numeral "3." (∃) displayed in the first digit. To display "3." in the LCD panel, it is necessary to apply the select or deselect voltage to the SEG4 and SEG8 pins according to Table 18-10 at the timing of the common signals COM0 to COM7; see Figure 18-30 for the relationship between the segment signals and LCD segments.

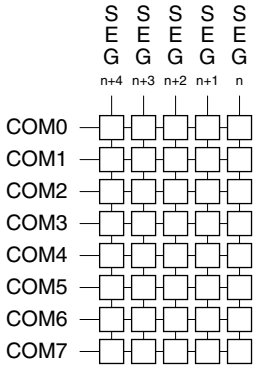
Table 18-10. Select and Deselect Voltages (COM0 to COM7)

Segment / Common	SEG4	SEG5	SEG6	SEG7	SEG8
COM0	Select	Select	Select	Select	Select
COM1	Deselect	Select	Deselect	Deselect	Deselect
COM2	Deselect	Deselect	Select	Deselect	Deselect
COM3	Deselect	Select	Deselect	Deselect	Deselect
COM4	Select	Deselect	Deselect	Deselect	Deselect
COM5	Select	Deselect	Deselect	Deselect	Select
COM6	Deselect	Select	Select	Select	Deselect
COM7	Deselect	Deselect	Deselect	Deselect	Deselect

According to Table 18-10, it is determined that the display data memory location (FA44H) that corresponds to SEG4 must contain 00110001.

Figure 18-32 shows examples of LCD drive waveforms between the SEG4 signal and each common signal. When the select voltage is applied to SEG4 at the timing of COM0, a waveform is generated to turn on the corresponding LCD segment.

Figure 18-30. Eight-Time-Slice LCD Display Pattern and Electrode Connections



<2> Error of baud rate

The baud rate error can be calculated by the following expression.

- $\text{Error (\%)} = \left(\frac{\text{Actual baud rate (baud rate with error)}}{\text{Desired baud rate (correct baud rate)}} - 1 \right) \times 100 \text{ [\%]}$

Caution Keep the baud rate error during transmission to within the permissible error range at the reception destination.

Example: Frequency of base clock = 2.5 MHz = 2,500,000 Hz
Set value of MC0BRS4 to MC0BRS0 bits of MC0CTL2 register = 10000B (k = 16)
Target baud rate = 76,800 bps

Baud rate = 2.5 M/(2 × 16)
= 2,500,000/(2 × 16) = 78125 [bps]

Error = (78,125/76,800 − 1) × 100
= 1.725 [%]

<3> Example of setting baud rate

Baud Rate [bps]	f_{PRS} = 10.0 MHz				f_{PRS} = 8.38 MHz				f_{PRS} = 8.0 MHz				f_{PRS} = 6.0 MHz			
	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]
4800	–	–	–	–	5, 6, or 7	27	4850	1.03	5, 6, or 7	26	4808	0.16	5, 6, or 7	20	4688	–2.34
9600	5, 6, or 7	16	9766	1.73	4	27	9699	1.03	5, 6, or 7	13	9615	0.16	4	20	9375	–2.34
19200	5	8	19531	1.73	3	27	19398	1.03	4	13	19231	0.16	4	10	18750	–2.34
31250	4	10	31250	0	2	17	30809	–1.41	4	8	31250	0	2	24	31250	0
38400	4	8	39063	1.73	2	27	38796	1.03	3	13	38462	0.16	2	20	37500	–2.34
56000	3	11	56818	1.46	2	19	55132	–1.55	3	9	55556	–0.79	1	27	55556	–0.79
62500	2	20	62500	0	2	17	61618	–1.41	3	8	62500	0	2	12	62500	0
76800	2	16	78125	1.73	1	27	77592	1.03	2	13	76923	0.16	2	10	75000	–2.34
115200	1	22	113636	–1.36	2	9	116389	1.03	1	17	117647	2.12	1	13	115385	0.16
125000	1	20	125000	0	1	17	123235	–1.41	1	16	125000	0	1	12	125000	0
153600	1	16	156250	1.73	2	7	149643	–2.58	1	13	153846	0.16	1	10	150000	–2.34
250000	1	10	250000	0	1	8	261875	4.75	1	8	250000	0	1	6	250000	0
					0	17	246471	–1.41								

Remark MC0CKS2 to MC0CKS0: Bits 2 to 0 of MCG control register 1 (MC0CTL1) (setting of base clock (f_{XCLK}))
k: Value set by bits 4 to 0 (MC0BRS4 to MC0BRS0) of MCG control register 2 (MC0CTL2) (k = 4, 5, 6, …, 31)
f_{PRS}: Peripheral hardware clock frequency
ERR: Baud rate error

<2> Error of baud rate

The baud rate error can be calculated by the following expression.

- $\text{Error (\%)} = \left(\frac{\text{Actual baud rate (baud rate with error)}}{\text{Desired baud rate (correct baud rate)}} - 1 \right) \times 100 \text{ [\%]}$

Caution Keep the baud rate error during transmission to within the permissible error range at the reception destination.

Example: Frequency of base clock = 2.5 MHz = 2,500,000 Hz
Set value of MC0BRS4 to MC0BRS0 bits of MC0CTL2 register = 10000B (k = 16)
Target baud rate = 76,800 bps

Baud rate = 2.5 M/(2 × 16)
= 2,500,000/(2 × 16) = 78125 [bps]

Error = (78,125/76,800 − 1) × 100
= 1.725 [%]

<3> Example of setting baud rate

Baud Rate [bps]	f_{PRS} = 10.0 MHz				f_{PRS} = 8.38 MHz				f_{PRS} = 8.0 MHz				f_{PRS} = 6.0 MHz			
	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]	MC0CKS2 to MC0CKS0	k	Calculated Value	ERR [%]
4800	–	–	–	–	5, 6, or 7	27	4850	1.03	5, 6, or 7	26	4808	0.16	5, 6, or 7	20	4688	–2.34
9600	5, 6, or 7	16	9766	1.73	4	27	9699	1.03	5, 6, or 7	13	9615	0.16	4	20	9375	–2.34
19200	5	8	19531	1.73	3	27	19398	1.03	4	13	19231	0.16	4	10	18750	–2.34
31250	4	10	31250	0	2	17	30809	–1.41	4	8	31250	0	2	24	31250	0
38400	4	8	39063	1.73	2	27	38796	1.03	3	13	38462	0.16	2	20	37500	–2.34
56000	3	11	56818	1.46	2	19	55132	–1.55	3	9	55556	–0.79	1	27	55556	–0.79
62500	2	20	62500	0	2	17	61618	–1.41	3	8	62500	0	2	12	62500	0
76800	2	16	78125	1.73	1	27	77592	1.03	2	13	76923	0.16	2	10	75000	–2.34
115200	1	22	113636	–1.36	2	9	116389	1.03	1	17	117647	2.12	1	13	115385	0.16
125000	1	20	125000	0	1	17	123235	–1.41	1	16	125000	0	1	12	125000	0
153600	1	16	156250	1.73	2	7	149643	–2.58	1	13	153846	0.16	1	10	150000	–2.34
250000	1	10	250000	0	1	8	261875	4.75	1	8	250000	0	1	6	250000	0
					0	17	246471	–1.41								

Remark MC0CKS2 to MC0CKS0: Bits 2 to 0 of MCG control register 1 (MC0CTL1) (setting of base clock (f_{XCLK}))
k: Value set by bits 4 to 0 (MC0BRS4 to MC0BRS0) of MCG control register 2 (MC0CTL2) (k = 4, 5, 6, …, 31)
f_{PRS}: Peripheral hardware clock frequency
ERR: Baud rate error

Table 23-1. Operating Statuses in HALT Mode (2/2)

HALT Mode Setting / Item			When HALT Instruction Is Executed While CPU Is Operating on Subsystem Clock
			When CPU Is Operating on XT1 Clock (f_{XT})
System clock			Clock supply to the CPU is stopped
	Main system clock	f_{RH}	Status before HALT mode was set is retained
		f_X	
		f_{EXCLK}	Operates or stops by external clock input
	Subsystem clock	f_{XT}	Operation continues (cannot be stopped)
	f_{RL}		Status before HALT mode was set is retained
CPU			Operation stopped
Flash memory			Operation stopped
RAM			Status before HALT mode was set is retained
Port (latch)			Status before HALT mode was set is retained
16-bit timer/event counter 00Note			Operable
8-bit timer/event counter		50Note	
		51Note	
		52Note	
8-bit timer		H0	
		H1	
		H2	
Real-time counter			
Watchdog timer			Operable. Clock supply to watchdog timer stops when “internal low-speed oscillator can be stopped by software” is set by option byte.
Clock output			Operable
Buzzer output			Operable. However, operation disabled when peripheral hardware clock (f_{PRS}) is stopped.
10-bit successive approximation type A/D converter			
16-bit ΔΣ type A/D converter			Operable
Serial interface		UART0	
		UART6	
		CSI10Note	
		CSIA0Note	
LCD controller/driver			
Manchester code generator			
Remote controller receiver			
Power-on-clear function			
Low-voltage detection function			
External interrupt			

Note When the CPU is operating on the subsystem clock and the internal high-speed oscillation clock has been stopped, do not start operation of these functions on the external clock input from peripheral hardware pins.

Remark f_{RH}: Internal high-speed oscillation clock
f_X: X1 clock
f_{EXCLK}: External main system clock
f_{XT}: XT1 clock
f_{RL}: Internal low-speed oscillation clock

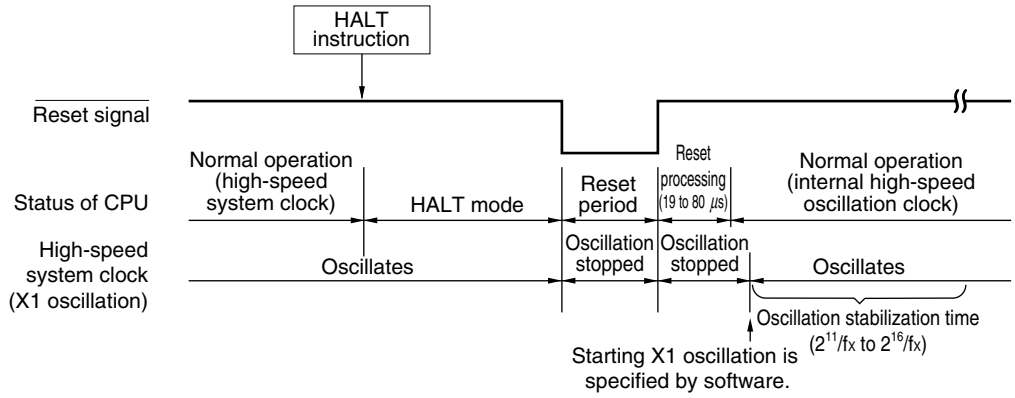
(b) Release by reset signal generation

When the reset signal is generated, HALT mode is released, and then, as in the case with a normal reset operation, the program is executed after branching to the reset vector address.

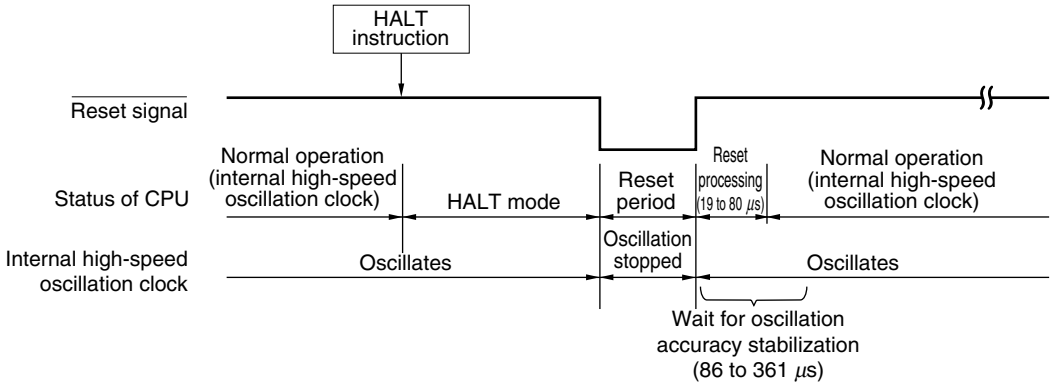
<R>

Figure 23-4. HALT Mode Release by Reset

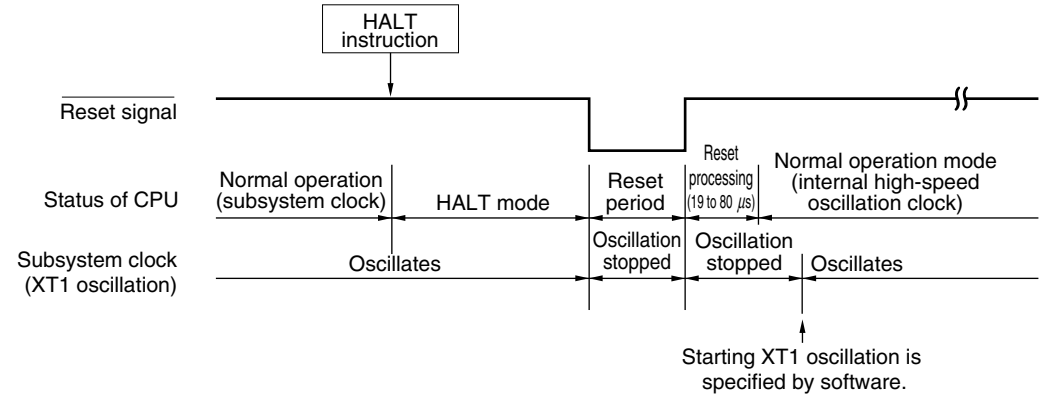
(1) When high-speed system clock is used as CPU clock



(2) When internal high-speed oscillation clock is used as CPU clock



(3) When subsystem clock is used as CPU clock



Remark fx: X1 clock oscillation frequency

28.3 Writing with Flash memory programmer

Data can be written to the flash memory on-board or off-board, by using a dedicated flash memory programmer.

(1) On-board programming

The contents of the flash memory can be rewritten after the 78K0/LF3 has been mounted on the target system. The connectors that connect the dedicated flash memory programmer must be mounted on the target system.

(2) Off-board programming

Data can be written to the flash memory with a dedicated program adapter (FA series) before the 78K0/LF3 is mounted on the target system.

Remark The FA series is a product of Naito Densei Machida Mfg. Co., Ltd.

Table 28-3. Wiring Between 78K0/LF3 and Dedicated Flash memory programmer

Pin Configuration of Dedicated Flash memory programmer			With CSI10		With UART6	
Signal Name	I/O	Pin Function	Pin Name	Pin No.	Pin Name	Pin No.
SI/RxD	Input	Receive signal	SO10/TxD0/P13	78	TxD6/SEG18/P112	36
SO/TxD	Output	Transmit signal	SI10/RxD0/P12	79	RxD6/SEG19/P113	35
SCK	Output	Transfer clock	$\overline{SCK10}$/P11	80	–	–
CLK	Output	Clock to 78K0/LF3	–Note 1	–	**Note 2**	**Note 2**
/RESET	Output	Reset signal	$\overline{RESET}$	14	$\overline{RESET}$	14
FLMD0	Output	Mode signal	FLMD0	17	FLMD0	17
V_{DD}	I/O	V_{DD} voltage generation/ power monitoring	V_{DD}	22	V_{DD}	22
			V_{DD}Note 3	59	V_{DD}Note 3	59
			AV_{REF}Note 4		AV_{REF}Note 4	
GND	–	Ground	V_{SS}	21	V_{SS}	21
			V_{SS}Note 3	60	V_{SS}Note 3	60
			AV_{SS}Note 4		AV_{SS}Note 4	

Notes 1. Only the internal high-speed oscillation clock (f_{RH}) can be used when CSI10 is used.

<R> **2.** Only the X1 clock (f_X), external main system clock (f_{EXCLK}), or internal high-speed oscillation clock (f_{RH}) can be used when UART6 is used. When using the clock output of the dedicated flash memory programmer, connect CLK of the PG-FP5 or FL-PR5 to EXCLK/X2/P122 (pin number 18).

3. μPD78F047x only.

4. μPD78F048x and 78F049x only.

<R> **Caution Only the bottom side pins (pin numbers 35 and 36) correspond to the UART6 pins (RxD6 and TxD6) when writing by a flash memory programmer. Writing cannot be performed by the top side pins (pin numbers 76 and 75).**

Instruction Group	Mnemonic	Operands	Bytes	Clocks		Operation	Flag
				Note 1	Note 2		Z AC CY
16-bit data transfer	**MOVW**	rp, #word	3	6	–	rp ← word	
		saddrp, #word	4	8	10	(saddrp) ← word	
		sfrp, #word	4	–	10	sfrp ← word	
		AX, saddrp	2	6	8	AX ← (saddrp)	
		saddrp, AX	2	6	8	(saddrp) ← AX	
		AX, sfrp	2	–	8	AX ← sfrp	
		sfrp, AX	2	–	8	sfrp ← AX	
		AX, rp Note 3	1	4	–	AX ← rp	
		rp, AX Note 3	1	4	–	rp ← AX	
		AX, !addr16	3	10	12	AX ← (addr16)	
		!addr16, AX	3	10	12	(addr16) ← AX	
	XCHW	AX, rp Note 3	1	4	–	AX ↔ rp	
8-bit operation	**ADD**	A, #byte	2	4	–	A, CY ← A + byte	× × ×
		saddr, #byte	3	6	8	(saddr), CY ← (saddr) + byte	× × ×
		A, r Note 4	2	4	–	A, CY ← A + r	× × ×
		r, A	2	4	–	r, CY ← r + A	× × ×
		A, saddr	2	4	5	A, CY ← A + (saddr)	× × ×
		A, !addr16	3	8	9	A, CY ← A + (addr16)	× × ×
		A, [HL]	1	4	5	A, CY ← A + (HL)	× × ×
		A, [HL + byte]	2	8	9	A, CY ← A + (HL + byte)	× × ×
		A, [HL + B]	2	8	9	A, CY ← A + (HL + B)	× × ×
		A, [HL + C]	2	8	9	A, CY ← A + (HL + C)	× × ×
	ADDC	A, #byte	2	4	–	A, CY ← A + byte + CY	× × ×
		saddr, #byte	3	6	8	(saddr), CY ← (saddr) + byte + CY	× × ×
		A, r Note 4	2	4	–	A, CY ← A + r + CY	× × ×
		r, A	2	4	–	r, CY ← r + A + CY	× × ×
		A, saddr	2	4	5	A, CY ← A + (saddr) + CY	× × ×
		A, !addr16	3	8	9	A, CY ← A + (addr16) + C	× × ×
		A, [HL]	1	4	5	A, CY ← A + (HL) + CY	× × ×
		A, [HL + byte]	2	8	9	A, CY ← A + (HL + byte) + CY	× × ×
		A, [HL + B]	2	8	9	A, CY ← A + (HL + B) + CY	× × ×
		A, [HL + C]	2	8	9	A, CY ← A + (HL + C) + CY	× × ×

Notes 1. When the internal high-speed RAM area is accessed or for an instruction with no data access

2. When an area except the internal high-speed RAM area is accessed

3. Only when rp = BC, DE or HL

4. Except “r = A”

Remarks 1. One instruction clock cycle is one cycle of the CPU clock (f_{CPU}) selected by the processor clock control register (PCC).

2. This clock cycle applies to the internal ROM program.

(c) CSI10 (Master mode, $\overline{SCK10}$... internal clock output)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
$\overline{SCK10}$ cycle time	t_{KCY1}	2.7 V ≤ V_{DD} ≤ 5.5 V	250			ns
		1.8 V ≤ V_{DD} < 2.7 V	500			ns
$\overline{SCK10}$ high-/low-level width	t_{KH1}, t_{KL1}	2.7 V ≤ V_{DD} ≤ 5.5 V	$t_{KCY1}/2 - 25$ Note 1			ns
		1.8 V ≤ V_{DD} < 2.7 V	$t_{KCY1}/2 - 50$ Note 1			ns
SI10 setup time (to $\overline{SCK10}$↑)	t_{SIK1}	2.7 V ≤ V_{DD} ≤ 5.5 V	80			ns
		1.8 V ≤ V_{DD} < 2.7 V	170			ns
SI10 hold time (from $\overline{SCK10}$↑)	t_{KSI1}		30			ns
Delay time from $\overline{SCK10}$↓ to SO10 output	t_{KSO1}	C = 50 pF Note 2			40	ns

Notes 1. This value is when high-speed system clock (f_{XH}) is used.

2. C is the load capacitance of the $\overline{SCK10}$ and SO10 output lines.

(d) CSI10 (Slave mode, $\overline{SCK10}$... external clock input)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
$\overline{SCK10}$ cycle time	t_{KCY2}			400			ns
$\overline{SCK10}$ high-/low-level width	t_{KH2}, t_{KL2}			$t_{KCY2}/2$			ns
SI10 setup time (to $\overline{SCK10}$↑)	t_{SIK2}			80			ns
SI10 hold time (from $\overline{SCK10}$↑)	t_{KSI2}			50			ns
Delay time from $\overline{SCK10}$↓ to SO10 output	t_{KSO2}	C = 50 pF Note	2.7 V ≤ V_{DD} ≤ 5.5 V			120	ns
			1.8 V ≤ V_{DD} < 2.7 V			165	ns

Note C is the load capacitance of the SO10 output line.